

# LI, YUXUAN

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## EDUCATION BACKGROUND

<b>National Chiao Tung University, Hsinchu City</b> <i>College of Electrical and Computer Engineering, Exchange student</i>	09/2018-01/2019
<b>South China University of Technology, Guangzhou</b> <i>Bachelor's Degree in Electrical Engineering and Automation    GPA: 3.74/4.00</i>	09/2016-06/2020
<b>Tsinghua University, Beijing</b> <i>School of Integrated Circuits</i>	09/2021-now

## RESEARCH EXPERIENCE

<b>Study on Coarse-Grained Reconfigurable Architecture (CGRA)</b> Participated in projects: <ul style="list-style-type: none"><li>•A Research on Airborne Intelligent Algorithm Adaptation for Domestic Reconfigurable Computing Chips</li><li>•A Research on Reconfigurable computing architecture for 6G communication</li></ul>	12/2021-11/2022
<b>Study on Dynamic Random Access Memory (DRAM)-based Near-Memory Processing</b> Participated in: <ul style="list-style-type: none"><li>•A research on Novel Time-Domain Computing Architecture Paradigm Based on DRAM</li></ul>	01/2022-now

## HONORS & AWARDS

Second-class Scholarship, School of Integrated Circuits, Tsinghua University	10/2022
Merit Student, South China University of Technology	06/2018
Third-class Scholarship, South China University of Technology	06/2018
Merit Student, South China University of Technology	06/2017
Second-class Scholarship, South China University of Technology	06/2017

## PERSONAL SKILLS

- Languages: English (IELTS 7.0, CET-6 616, CET-4 617)  
Japanese (JLPT N2)
- IT Skills: C++ (National Computer Rank Examination Grade 2 )  
Verilog